

GBU4A thru GBU4G

GBU Package

Single Phase Glass Passivated Silicon Bridge Rectifier

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High case dielectric strength of 1500 V_{RMS}
- Glass passivated chip junction
- · Ideal for printed circuit boards
- · High surge overload rating
- High temperature soldering guaranteed: $260^{\circ}C/10$ seconds, 0.375 (9.5mm) lead length
- · Not ESD Sensitive

Mechanical Data

Case: Molded plastic body over passivated junctions Terminals: Plated leads, solderable per MIL-STD-750 Method 2026. Mounting position: Any

Maximum ratings at Tc = 25 °C, unless otherwise specified

Parameter	· s	ymbol	Conditions	GBU4A	GBU4B	GBU4D	GBU4G	Unit
Repetitive peak reverse	voltage	V _{RRM}		50	100	200	400	V
RMS reverse voltage		V _{RMS}		35	70	140	280	V
DC blocking voltage		V _{DC}		50	100	200	400	V
Operating temperature		Tj		-55 to 150	-55 to 150	-55 to 150	-55 to 150	°C
Storage temperature		T _{stg}		-55 to 150	-55 to 150	-55 to 150	-55 to 150	°C

Electrical characteristics at Tc = 25 °C, unless otherwise specified

Single phase, half sine wave, 60 Hz, resistive or inductive load

For capacitive load derate current by 20%

Parameter	Symbol	Conditions	GBU4A	GBU4B	GBU4D	GBU4G	Unit
Maximum average forward rectified current ^{1,2}	Ι _Ο	T _c = 100 °C	4.0	4.0	4.0	4.0	А
Peak forward surge current	I _{FSM}	t _p = 8.3 ms, half sine	150	150	150	150	А
Maximum instantaneous forward voltage drop per leg	V_{F}	I _F = 4 A	1.1	1.1	1.1	1.1	V
Maximum DC reverse current at	I _R	T _a = 25 °C	5	5	5	5	μΑ
rated DC blocking voltage per leg		T _a = 125 °C	500	500	500	500	
Rating for fusing	l ² t	t < 8.3 ms	93	93	93	93	A ² sec
Typical junction capacitance per leg ³	C _j		100	100	100	100	pF
Typical thermal resistance per lag 1,2	$R_{\Theta JA}$		22	22	22	22	
Typical thermal resistance per leg ^{1,2}	$R_{\Theta JL}$		4.2	4.2	4.2	4.2	°C/W

¹ - Device mounted on 40 mm x 40 mm x 1.5 mm Al plate heatsink

² - Recommended mounted position is to bolt down device on a heatsink with silicon

thermal compond for maximum heat transfer using #6 screw.

 $^{\rm 3}$ - Measured at 1.0 MHz and applied reverse bias of 4.0 V





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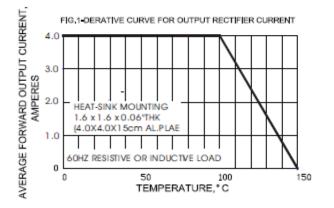
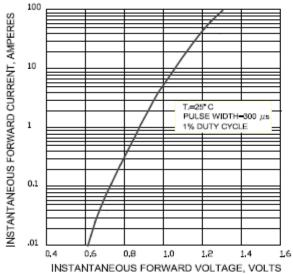
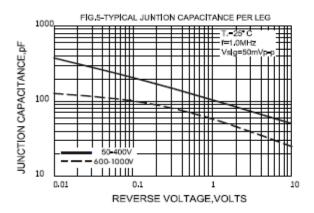
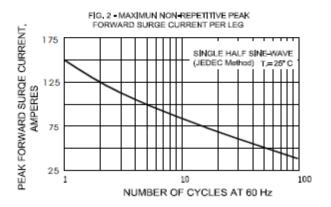
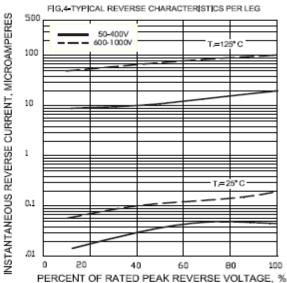


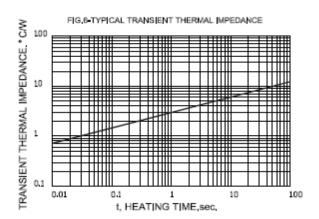
FIG.3-TYPICAL FORWARD CHARACTERISTICS PER LEG









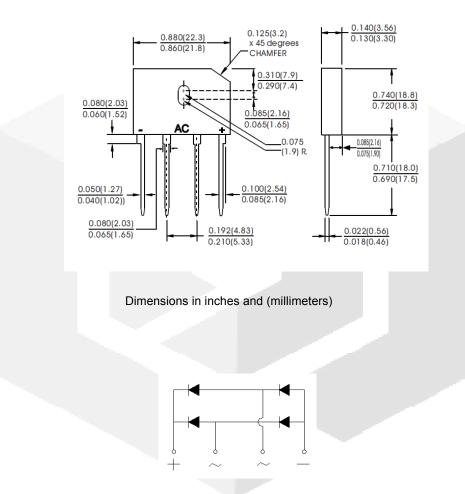






Package dimensions and terminal configuration

Product is marked with part number and terminal configuration.



GBU

